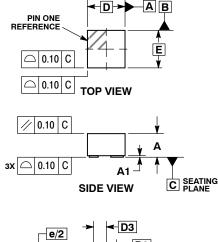
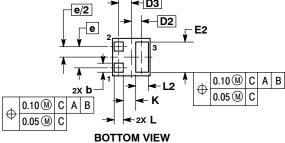




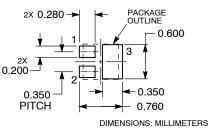
XLLGA3, 0.62x0.62, 0.35P CASE 713AB ISSUE O

DATE 25 SEP 2012

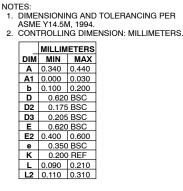




RECOMMENDED SOLDER FOOTPRINT*



*For additional information on our Pb–Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.



GENERIC MARKING DIAGRAM*



X = Specific Device Code

M = Date Code

*This information is generic. Please refer to device data sheet for actual part marking. Pb–Free indicator, "G", may or not be present.

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DESCRIPTION:	XLLGA3, 0.62X0.62, 0.35P		PAGE 1 OF 1
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